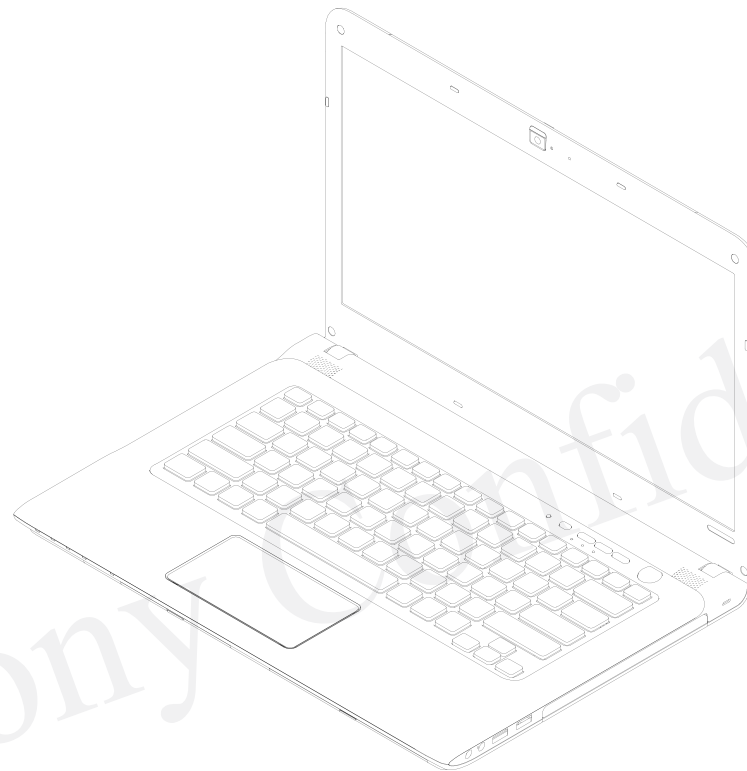


SVE14A Series

SERVICE MANUAL

Ver.1-2012C

Revision History



●Design and specifications are subject to change without notice.

PERSONAL COMPUTER

SONY®

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Caution Markings for Lithium/Ion Battery - The following or similar texts shall be provided on battery pack of equipment or in both the operating and the service instructions.

CAUTION: Danger of explosion if battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer. Discard used batteries according to the manufacturer's instructions.

CAUTION: The battery pack used in this device may present a fire or chemical burn hazard if mis-treated. Do not disassemble, heat above 60°C (140°F) or incinerate. Dispose of used battery promptly. Keep away from children.

CAUTION: Changing the back up battery.

- Overcharging, short circuiting, reverse charging, mutilation or incineration of the cells must be avoided to prevent one or more of the following occurrences; release of toxic materials, release of hydrogen and/or oxygen gas, rise in surface temperature.

- If a cell has leaked or vented, it should be replaced immediately while avoiding to touch it without any protection.

The components identified by mark  contain confidential information. Strictly follow the instructions whenever the components repaired and/or replaced.

Service and Inspection Precautions

1. Obey precautionary markings and Instructions

Labels and stamps on the cabinet, chassis, and components identify areas requiring special precautions. Be sure to observe these precautions, as well as all precautions listed in the operating manual and other associated documents.

2. Use designated parts only

The set's components possess important safety characteristics, such as noncombustibility and the ability to tolerate large voltages. Be sure that replacement parts possess the same safety characteristics as the originals. Also remember that the  mark, which appears in circuit diagrams and parts lists, denotes components that have particularly important safety functions; be extra sure to use only the designated components.

3. Always follow the original design when mounting parts and routing Wires

The original layout includes various safety features, such as inclusion of insulating materials (tubes and tape) and the mounting of parts above the printer board. In addition, internal wiring has been routed and clamped so as to keep it away from hot or high-voltage parts. When mounting parts or routing wires, therefore, be sure to duplicate the original layout.

4. Inspect after completing service

After servicing, inspect to make sure that all screws, components, and wiring have been returned to their original condition. Also check the area around the repair location to ensure that repair work has caused no damage, and confirm safety.

5. When replacing chip components...

Never reuse components. Also remember that the negative side of tantalum capacitors is easily damaged by heat.

6. When handling flexible print boards...

- The temperature of the soldering-iron tip should be about 270°C.
- Do not apply the tip more than three times to the same pattern.
- Handle patterns with care; never apply force.

Caution: Remember that hard disk drives are easily damaged by vibration. Always handle with care.

**ATTENTION AU COMPOSANT AYANT
RAPPORT
À LA SÉCURITÉ!**
**LES COMPOSANTS IDENTIFIÉS PAR UNE
MARQUE  SUR LES DIAGRAMMES
SCHÉMATIQUES ET LA LISTE DES PIÈCES
SONT CRITIQUES POUR LA SÉCURITÉ DE
FONCTIONNEMENT. NE REMPLACER CES
COMPOSANTS QUE PAR DES PIÈCES SONY
DONT LES NUMÉROS SONT DONNÉS
DANS CE MANUEL OU DANS LES
SUPPLÉMENTS PUBLIÉS PAR SONY.**

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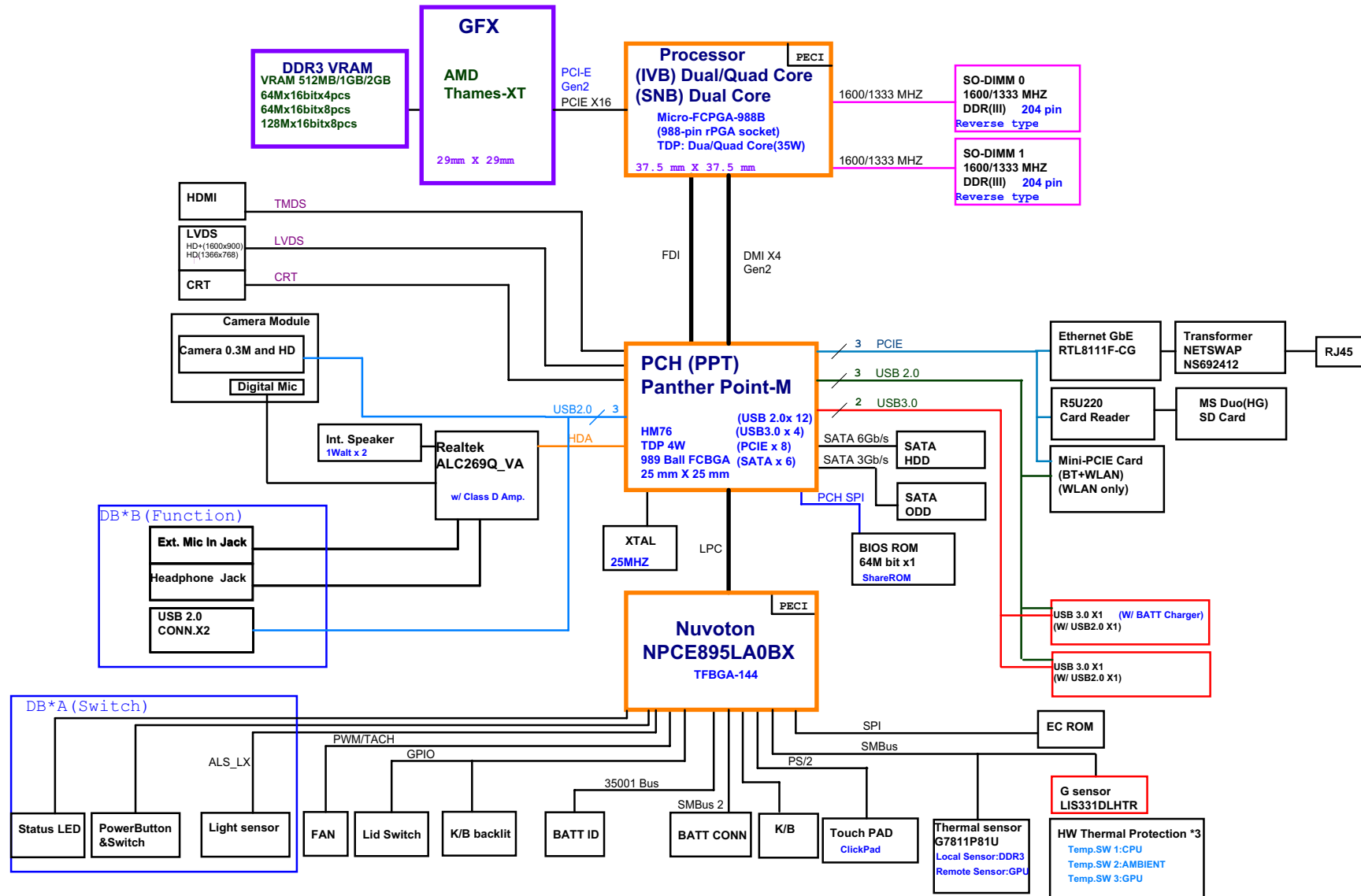
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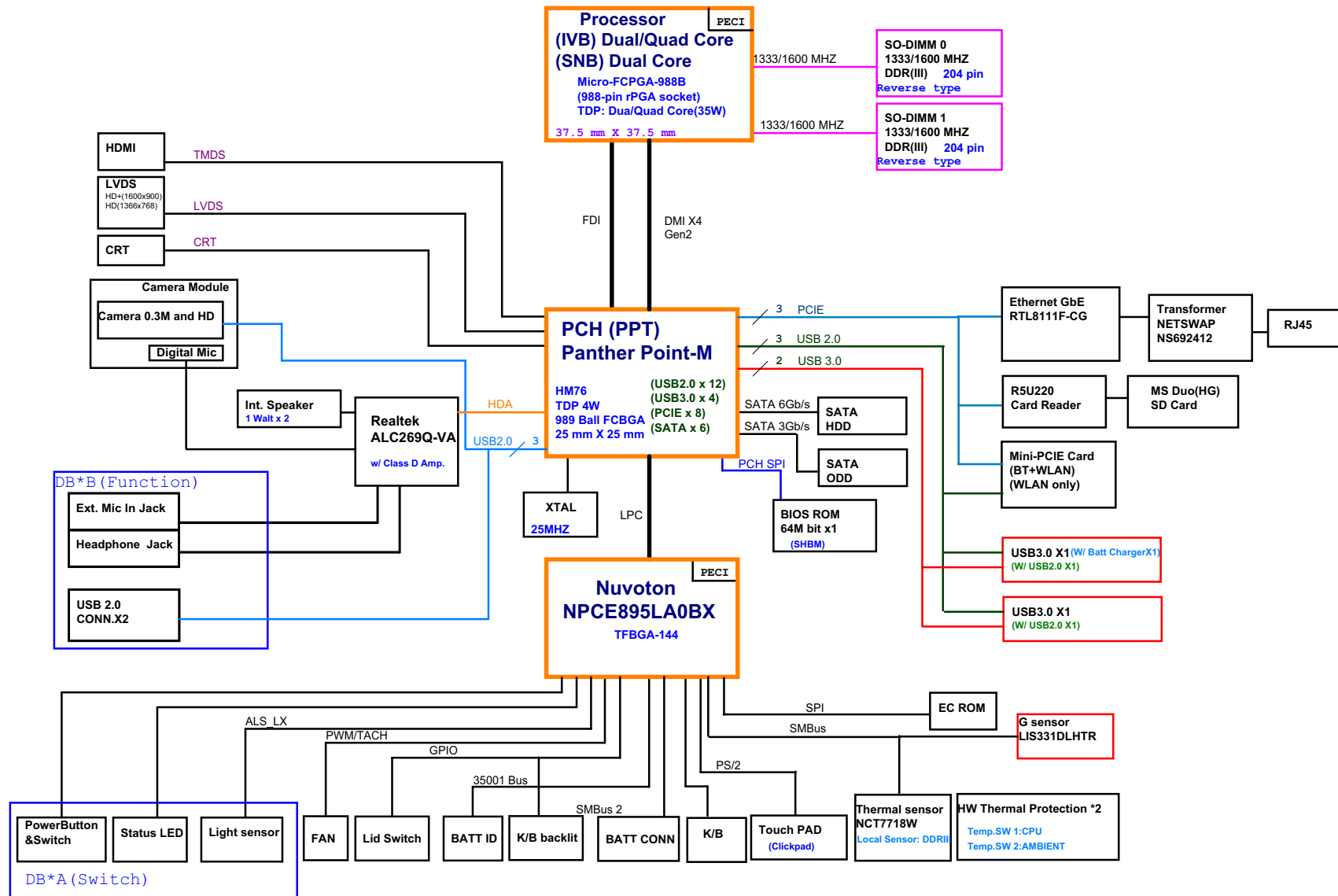
- History of the changes is shown as the “Revision History” at the end of this data.

CHAPTER1. BLOCK DIAGRAM

1-1.SVE14A Series (For Ext-Gfx (THAMES-XT(M)) Models)



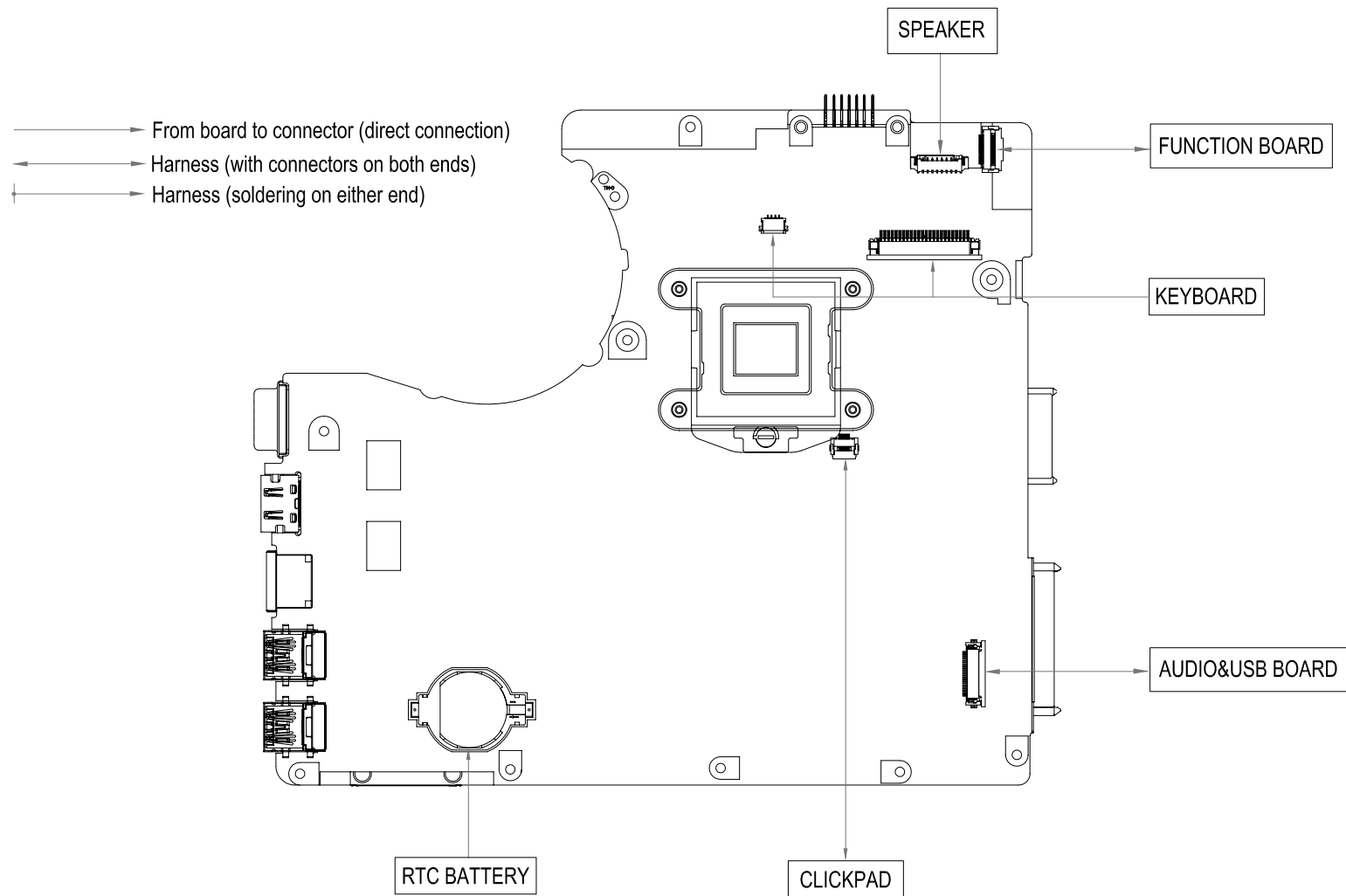
1-2.SVE14A Series (For Int-Gfx Models)



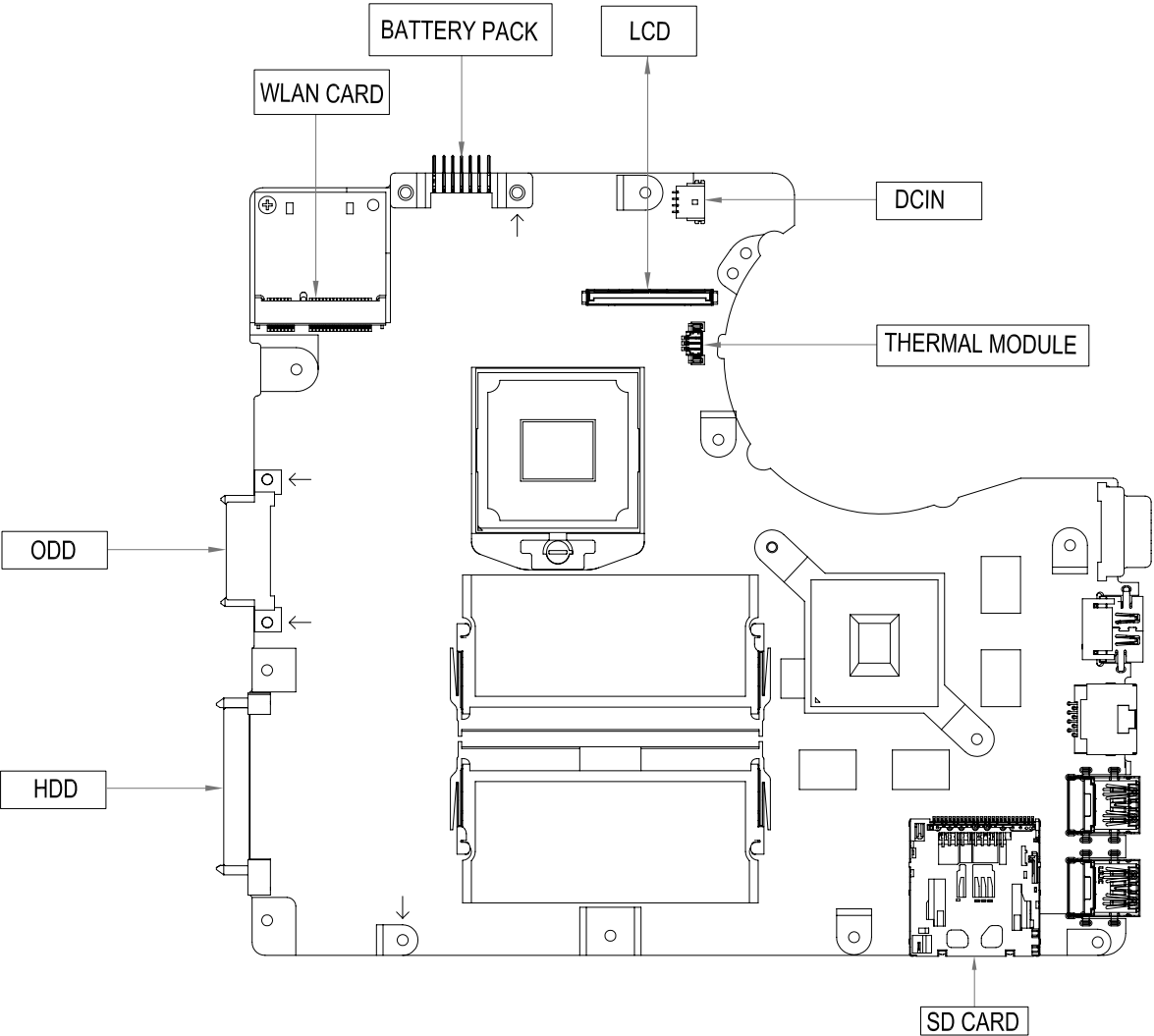
CHAPTER2.

FRAME HARNESS DIAGRAM

2-1.SVE14A Series (TOP)

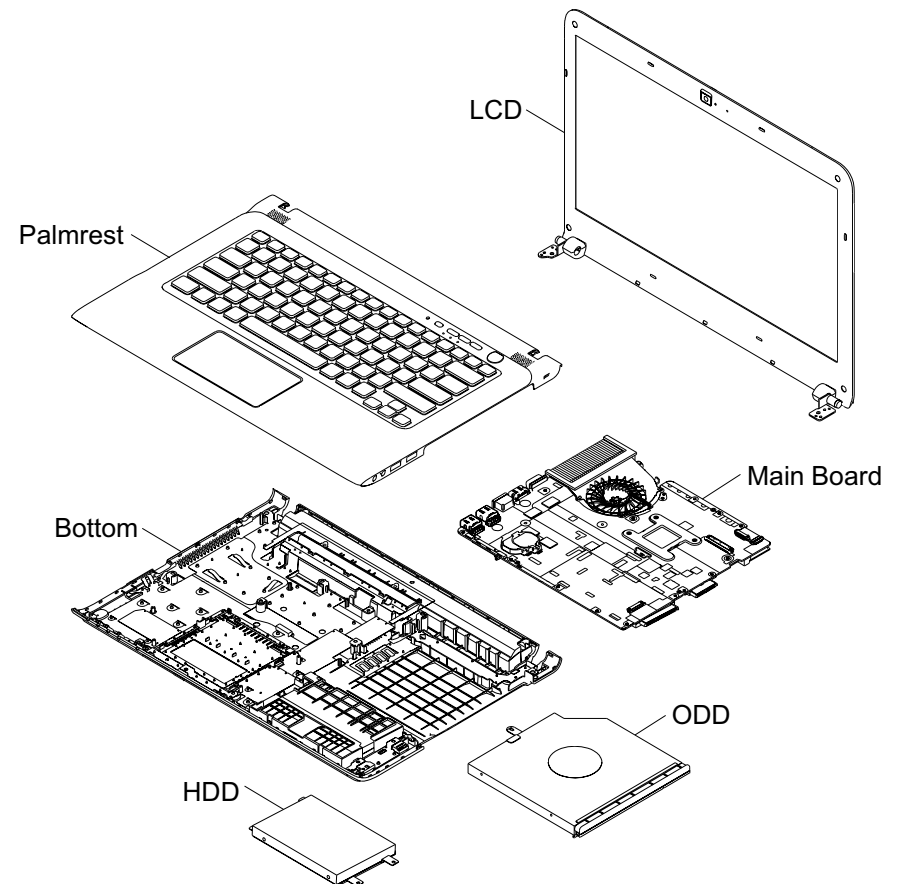


2-2.SVE14A Series (BOTTOM)



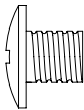
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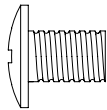
S-1. Screws

B1



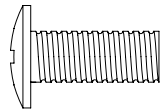
M2*L2
Sliver

B2



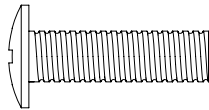
M2*L3
Black

B3



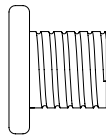
M2*L5
Sliver

B4



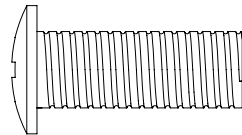
M2*L7
Black

B5



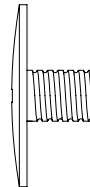
I3*L3
Sliver

B6



M3*L8
Black

B7



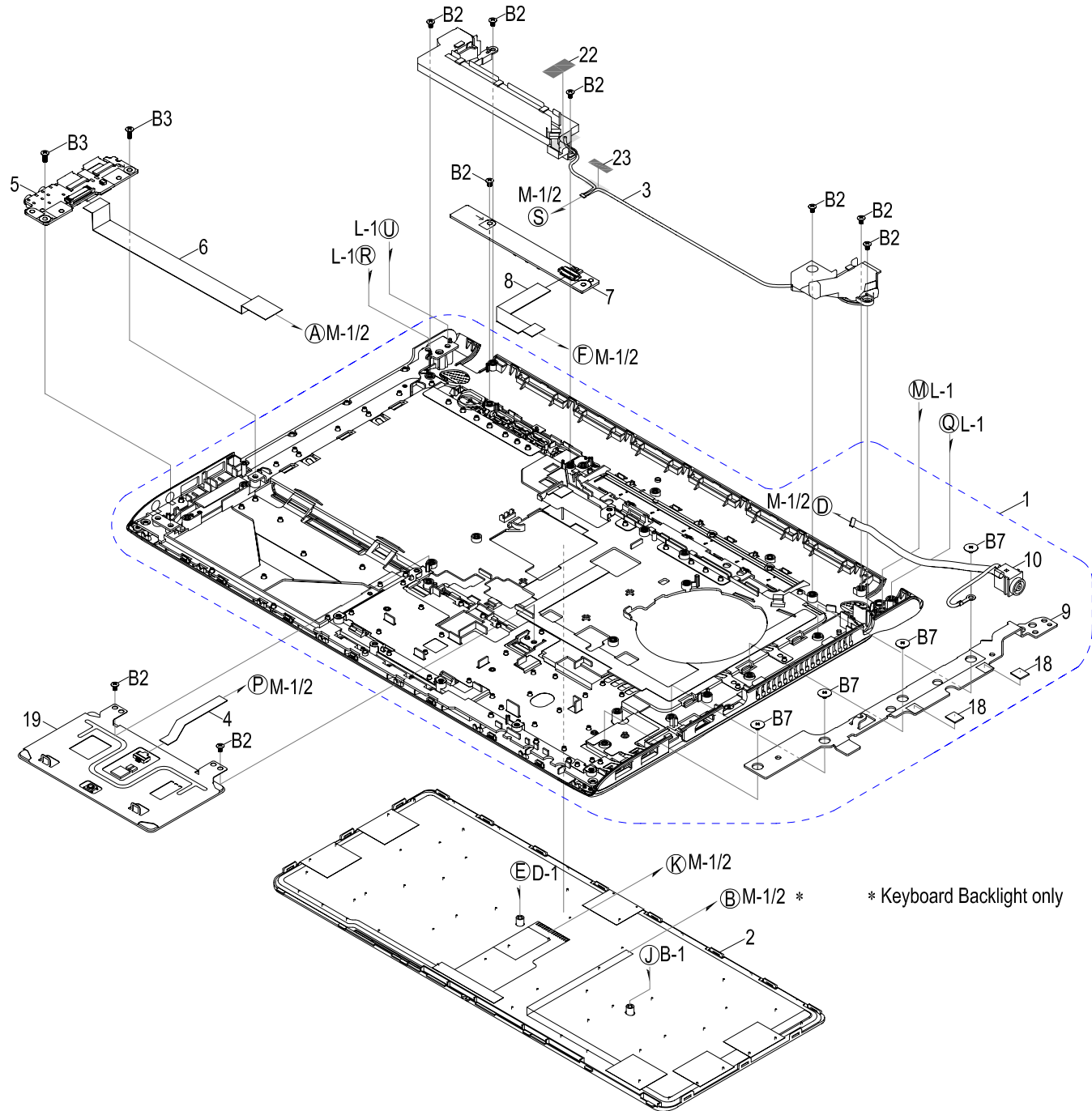
M2*L2.5
Black

B10

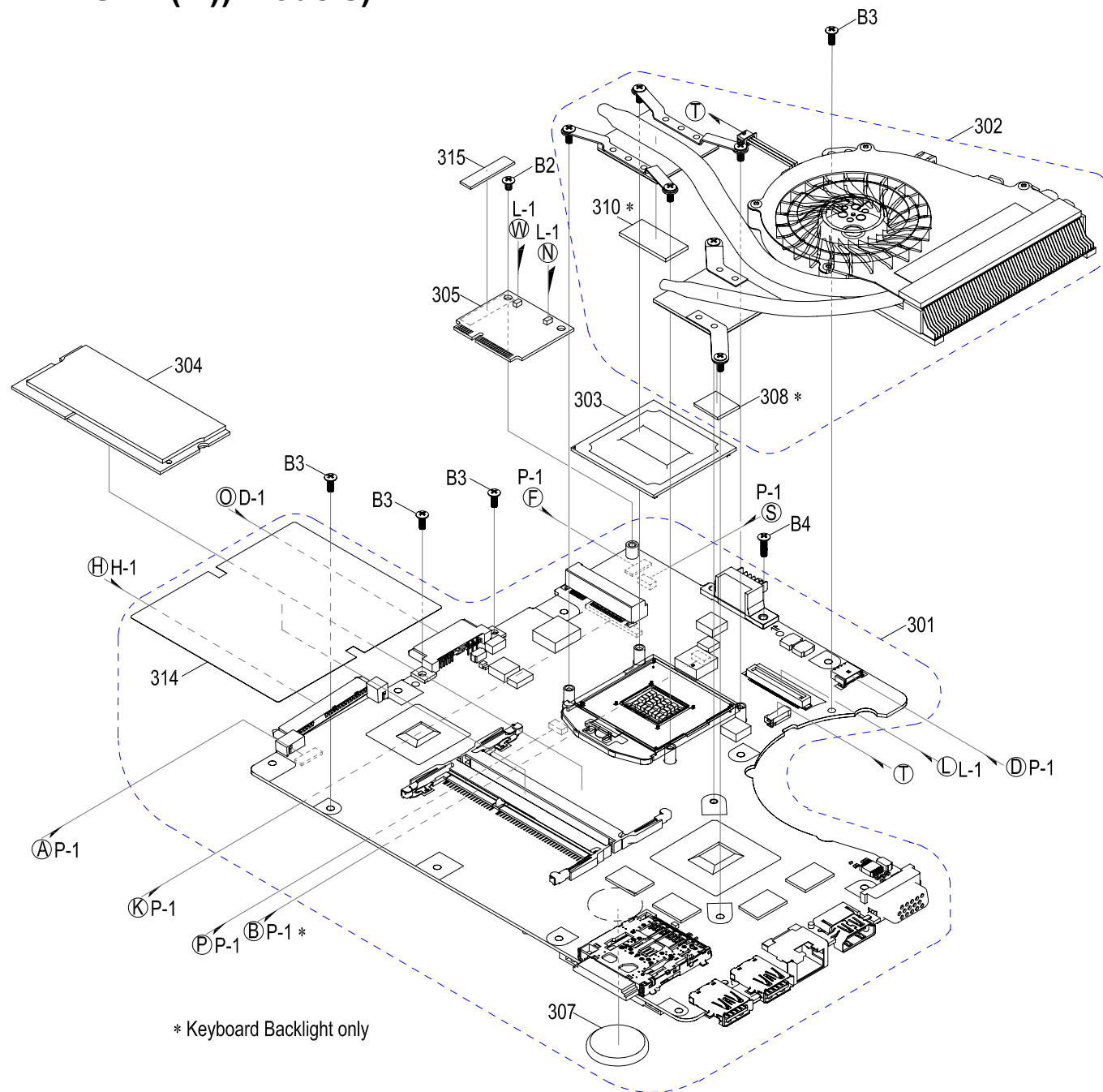
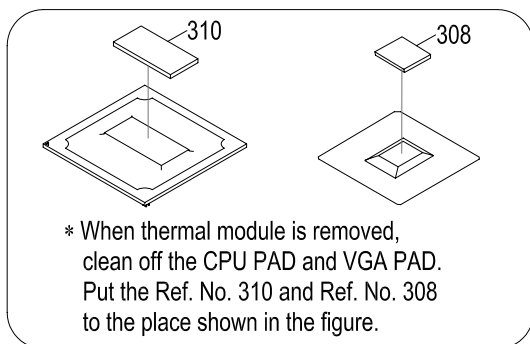


I2*L3
Black

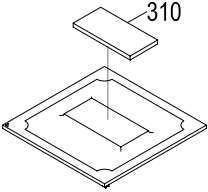
P-1. Palmrest



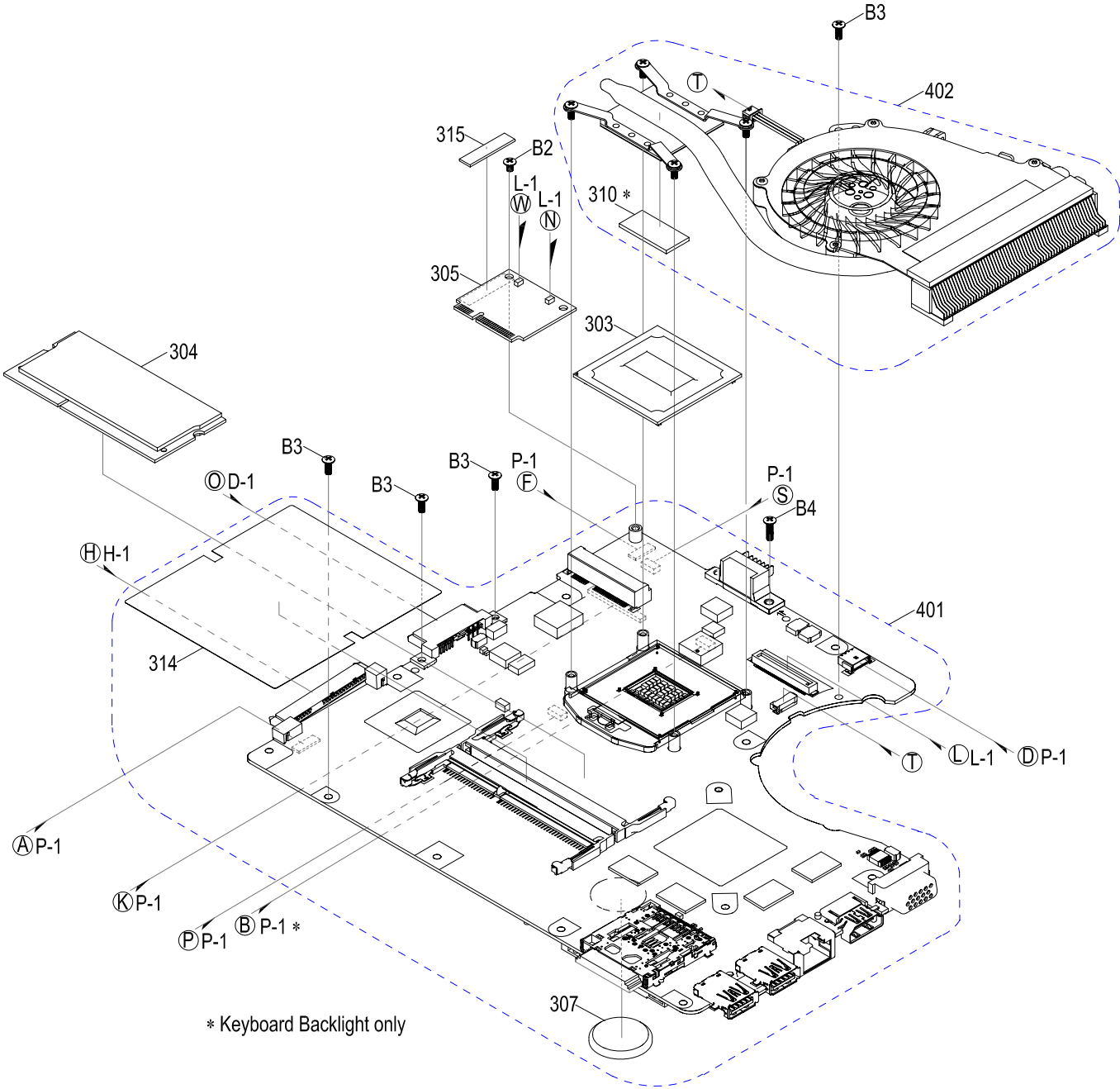
M-1. Main Board (For Ext-Gfx (THAMES-XT(M)) Models)



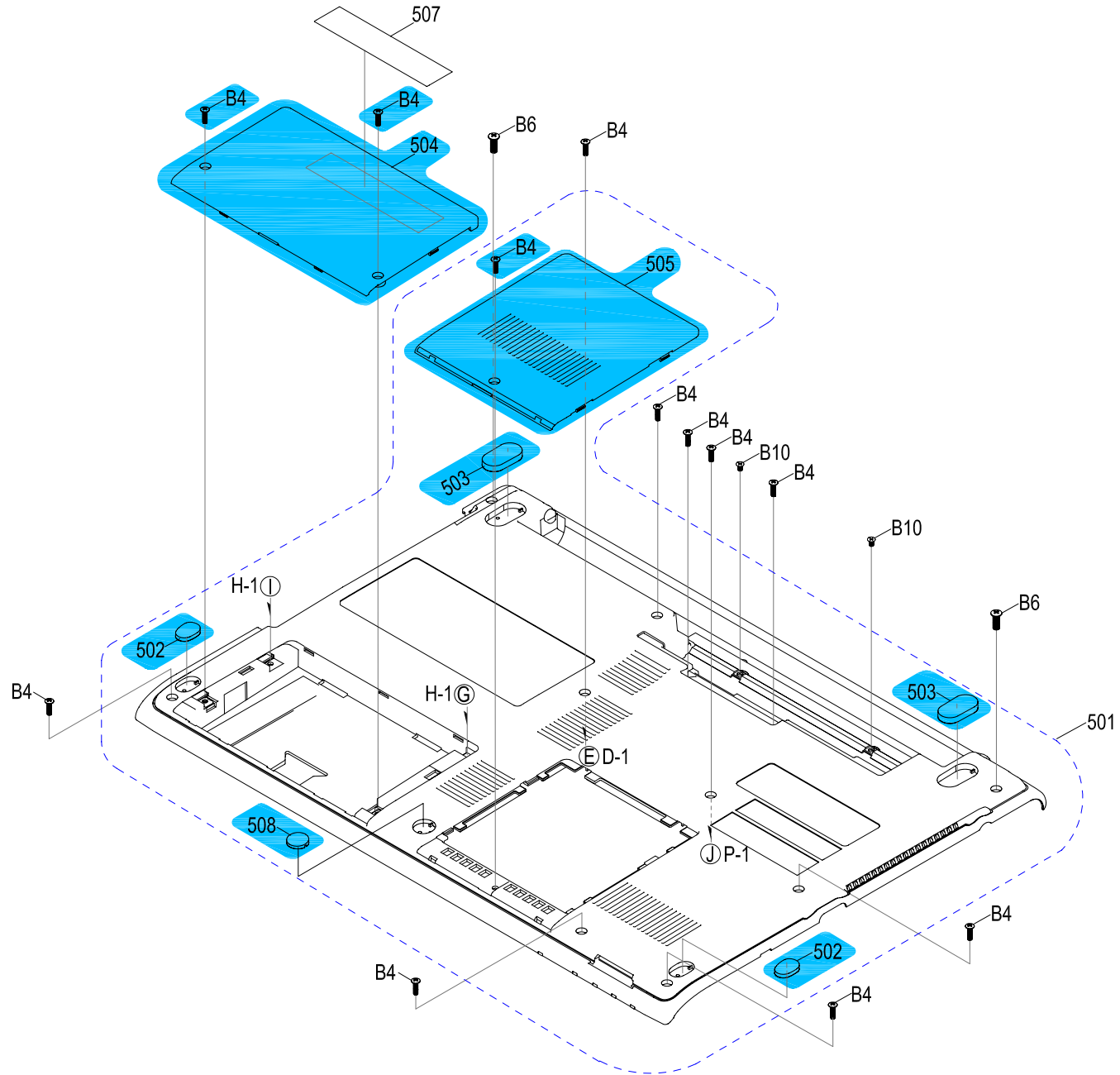
M-2. Main Board (For Int-Gfx Models)

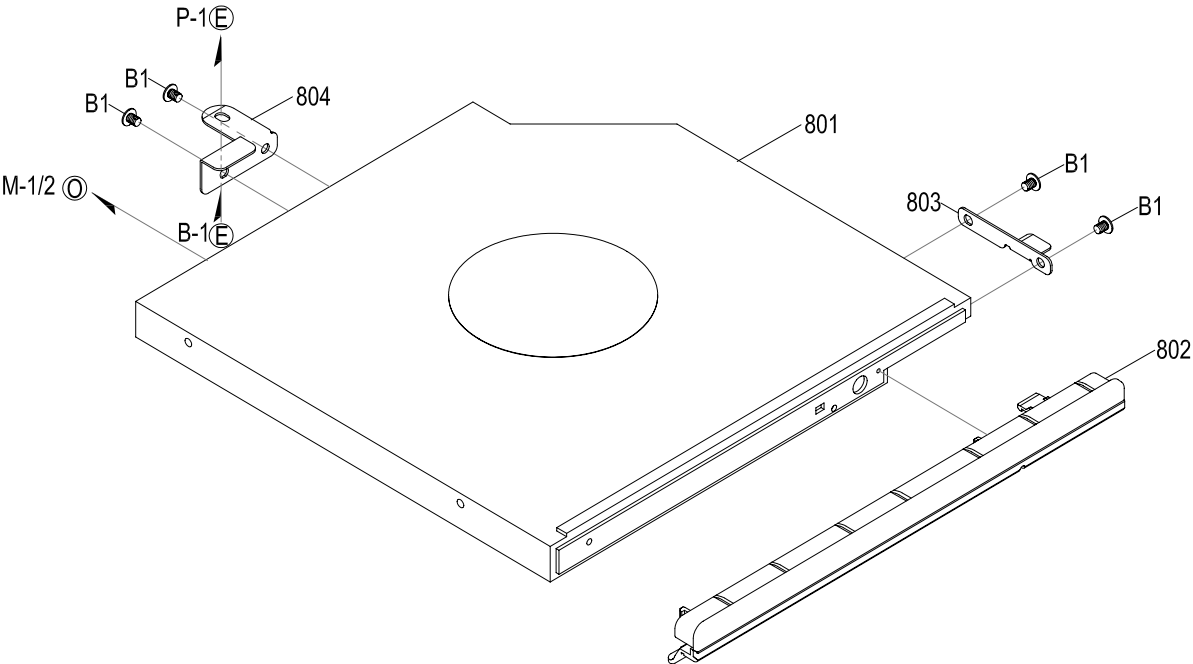


* When thermal module is removed, clean off the CPU PAD. Put the Ref. No. 310 to the place shown in the figure.

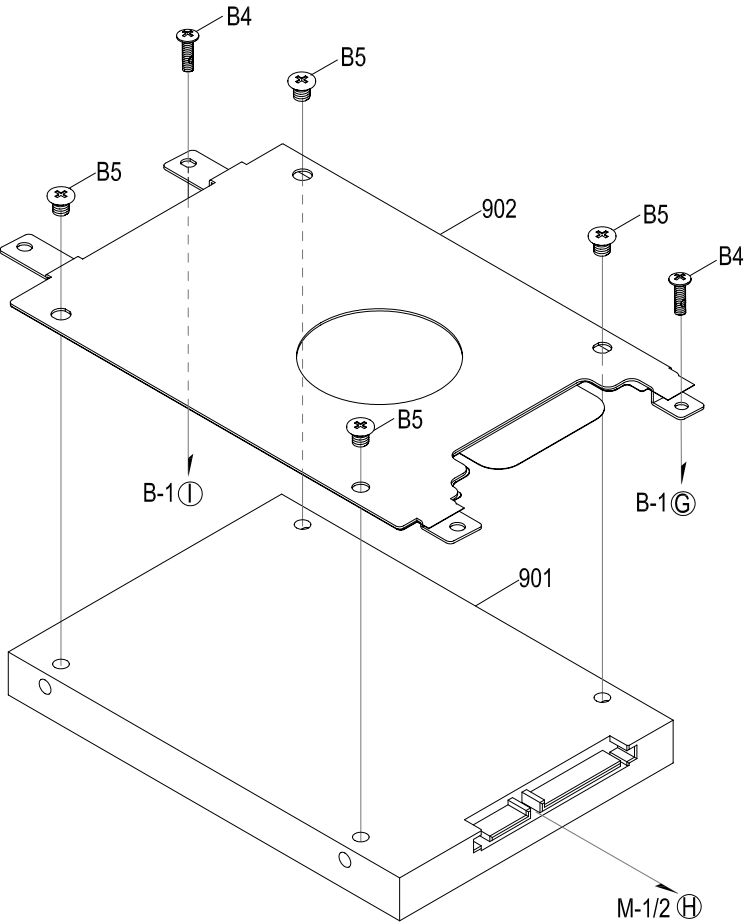


B-1. Bottom

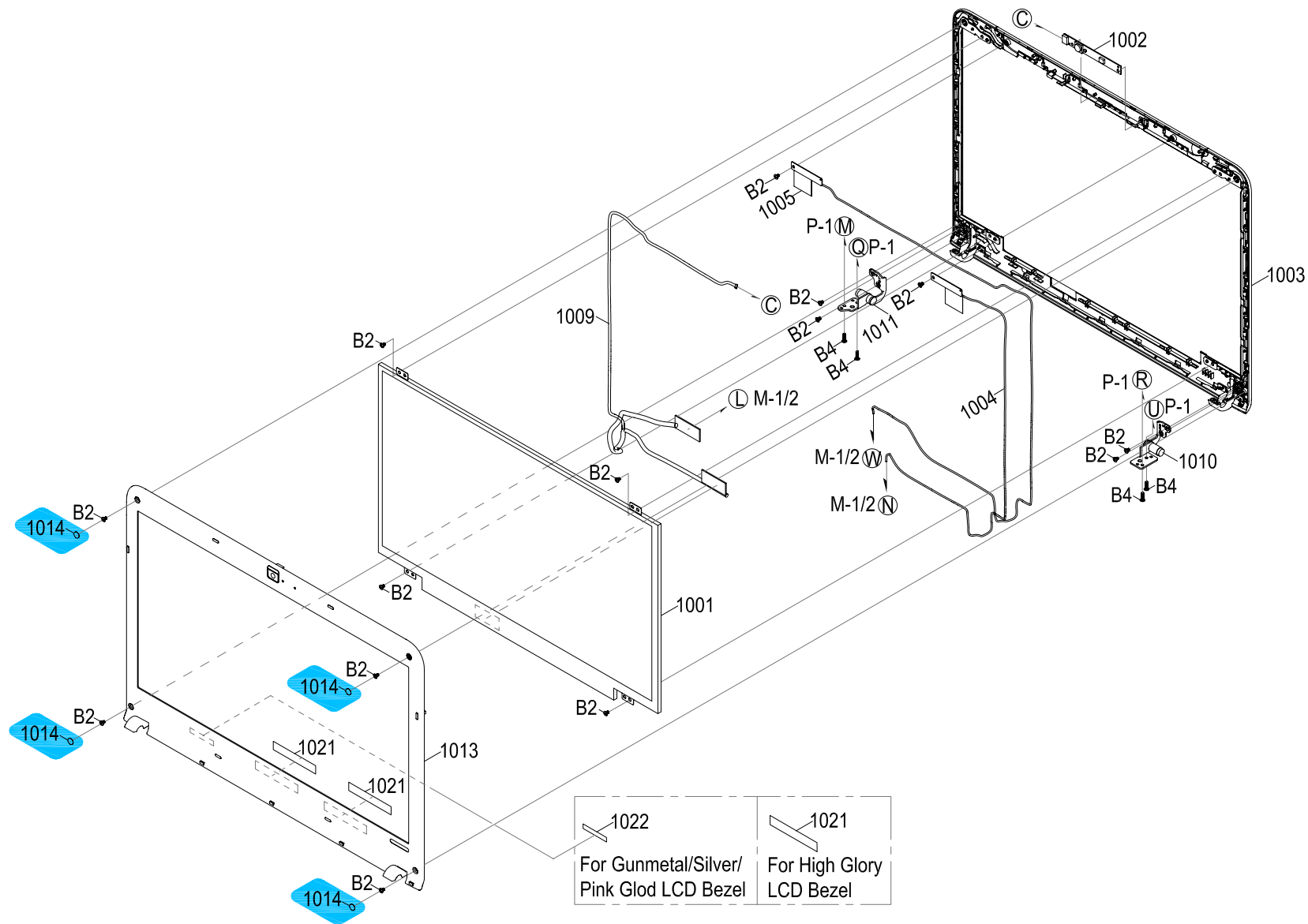




H-1. HDD



L-1. LCD



A-1. Accessories

2005
Power Cord



2006
AC Adapter



2006
AC Adapter(Stick Type)



2007
Battery Pack



2008
Carrying Case



2009
Bluetooth Mouse



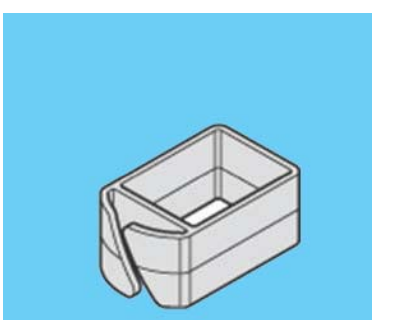
2010
Keyboard Skin



2011
Carrying Pouch



2012
Cable Clip

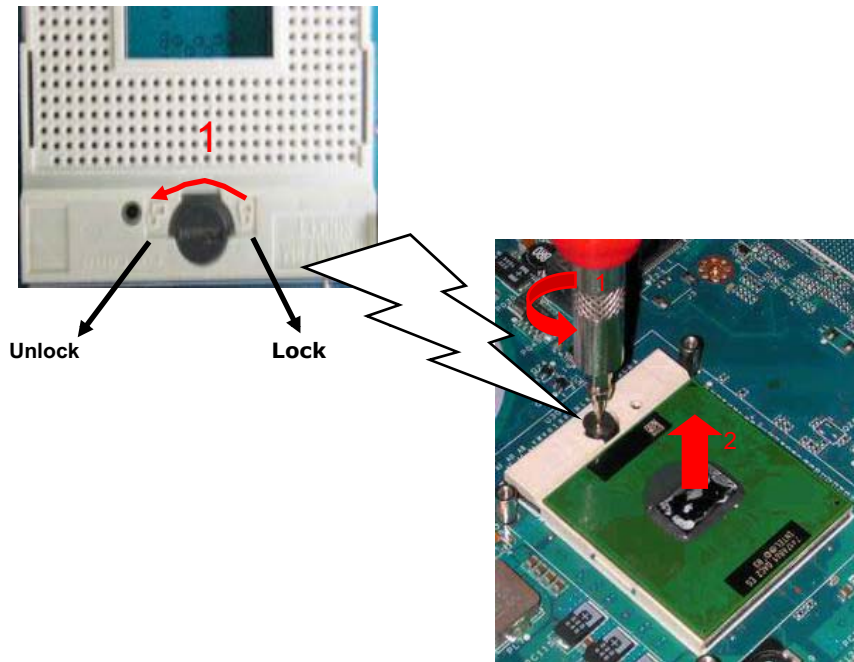


CHAPTER4. OTHERS

4-1. Replacing the CPU

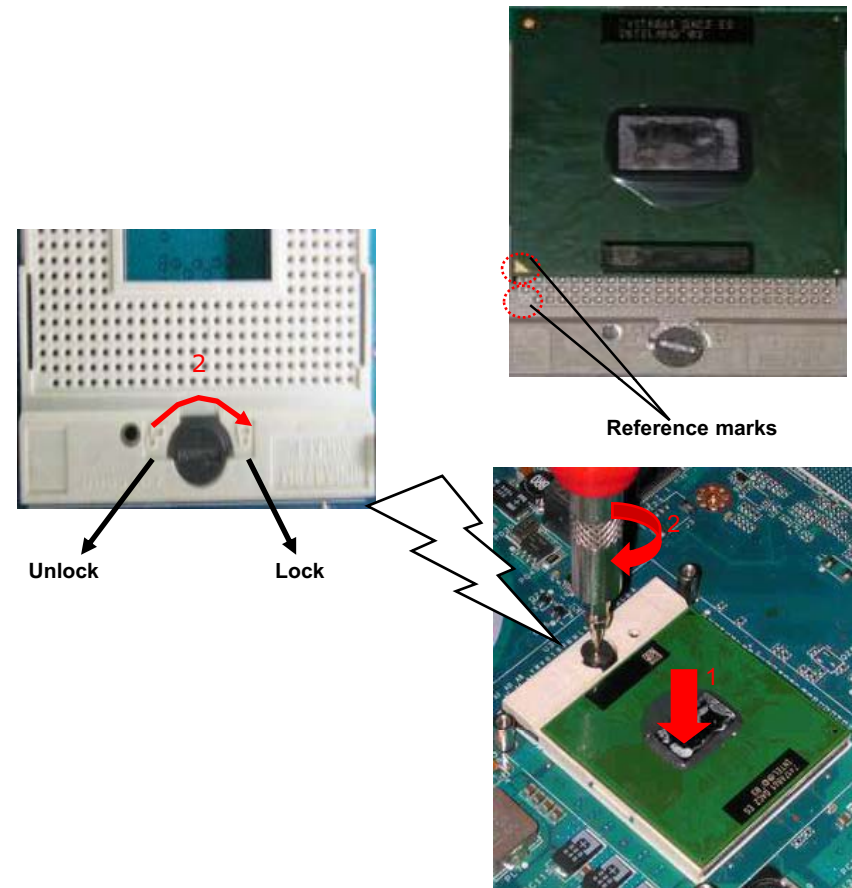
1. Removing the CPU

1. Insert a flat-blade screwdriver into the notch as shown illustration and rotate it so that the protrusion comes to the lock release position.
2. Pull the CPU gently upward to lift it out of the CPU socket



2. Installing the CPU

1. Align the triangle reference mark of the mark the CPU with that of the CPU socket and insert all the pins of the CPU to the corresponding holes of the CPU socket.
2. Insert the flat head (-) screwdriver into the specified position and rotate the screwdriver to the LOCK position.

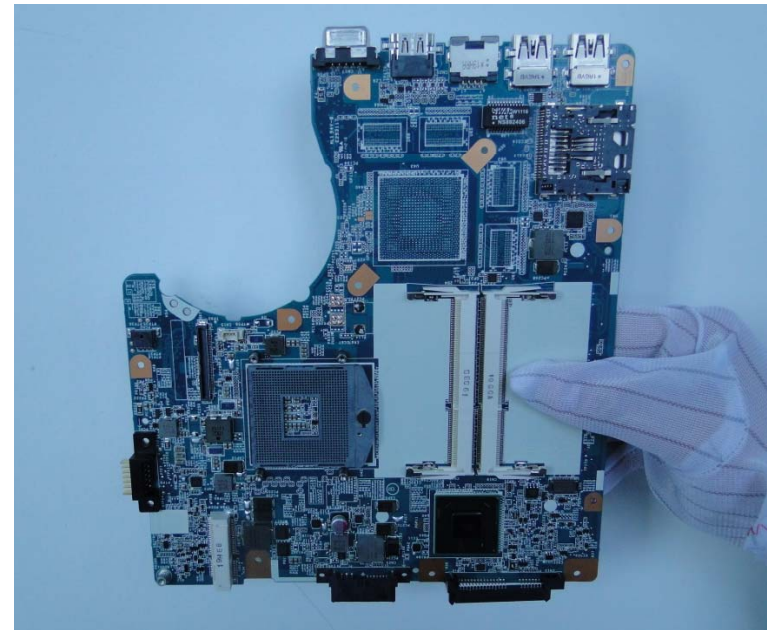


4-2 Holding Method of Motherboard

1. When operating with both hands, gently hold the middle of Main board edge as show.
2. When operating with one-hand, gently hold the middle of Main board edge and keep vertical.



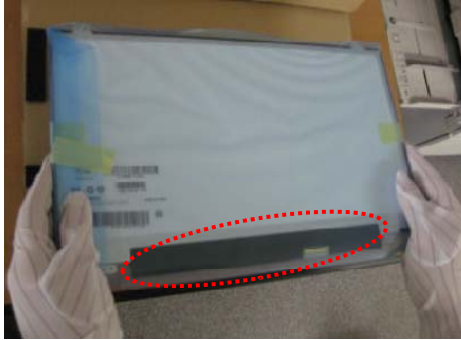
(Level)



(Vertical)

4-3 Handling and Holding Method of LCD

1. Handling Method of LCD



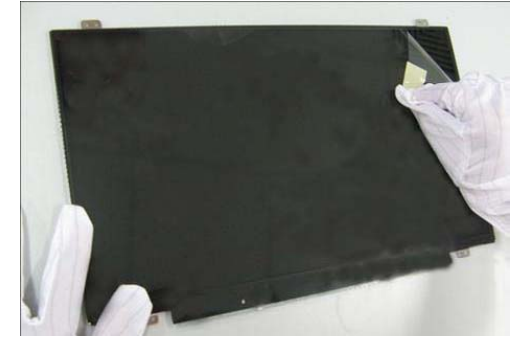
1) Take LCD Panel out of packing box with its both sides.
Note not to press the PCB.



2) Holding the opposite side of PCB with one hand, take off the tape of shielding bag with the other hand.



3) Holding one side of LCD Panel with one hand, take off the shielding bag with the other hand.

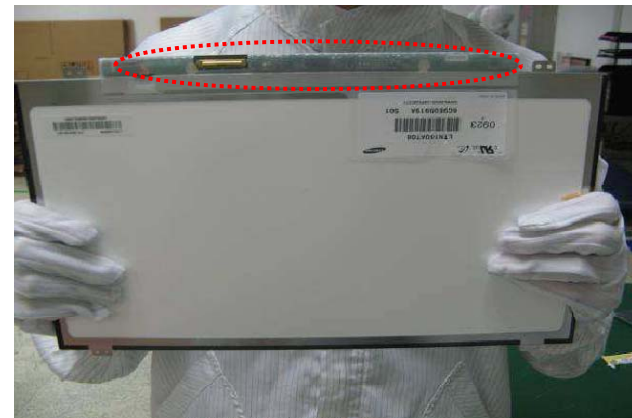


4) Besides the protector sheet, there is also another soft film on the surface of Samsung LCD. The soft film is under the protector sheet. Remove it carefully with one tape.

2. Holding Method of LCD



(Front View)



(Rear View)



SVE14A Series

Revision History

Suffix	Ver.	Date	Contents	QM No.
-01	Ver.1	2012.03.26	First Edition	
<Remarks>				